

B133EW01 V9

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(V) Final Specifications

Module	13.3" WXGA Color TFT-LCD
Model Name	B133EW01 V9 H/W:0A
Dell Part No.	DW909

Customer Date	Approved by Date
Checked & Approved by	Prepared by
Note: This Specification is subject to change without notice.	MDBU Marketing Division / AU Optronics corporation

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Record of Revision

Version and Date	Page	Old description	New Description	Remark
0.1 2007/11/26	AII	First Edition for Customer		
0.2 2007/12/13	29	Label:REV X00	Label:REV A00	
0.3 2008/1/22	29		Definition of customer PPID Label and Revision Code	
0.4 2008/3/14	1	Preliminary spec	Final spec	
		Color chromaticity: R(0.580, 0.340), G(0.310,0.550), B(0.155, 0.155)	Color chromaticity: R(0.600, 0.350), G(0.310,0.565), B(0.155, 0.150)	
	26/27	Lamp wire lenth: 90mm	Lamp wire lenth: 65mm	

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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) In case if a Module has to be put back into the packing container slot after once it was taken out from the container, do not press the center of the CCFL Reflector edge. Instead, press at the far ends of the CFL Reflector edge softly. Otherwise the TFT Module may be damaged.
- 10) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Cold cathode fluorescent lamp in LCD contains a small amount of mercury. Please follow local ordinances or regulations for disposal.
- 13) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source(, IEC60950 or UL1950), or be applied exemption.
- 14) The LCD module is designed so that the CCFL in it is supplied by Limited Current Circuit(IEC60950 or UL1950). Do not connect the CCFL in Hazardous Voltage Circuit.

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2. General Description

B133EW01 V9 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and backlight system. The screen format is intended to support the WXGA (1280(H) x 800(V)) screen and 262k colors (RGB 6-bits data driver). All input signals are LVDS interface compatible. Inverter of backlight is not included.

B133EW01 V9 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $\,^{\circ}\!\mathrm{C}\,$ condition:

Items	Unit	Specifications
Screen Diagonal	[mm]	337.8 (13.3 W")
Active Area	[mm]	286.08 (H) x 178.8 (V)
Pixels H x V		1280x3(RGB) x 800
Pixel Pitch	[mm]	0.2235 x 0.2235
Pixel Arrangement		R.G.B. Vertical Stripe
Display Mode		Normally White
White Luminance (IccFL=6.0mA)	[cd/m ²]	220 typ. (5 points average)
Note: IccFL is lamp current		200 min. (5 points average) (Note1)
Luminance Uniformity		1.25 max. (5 points)
Contrast Ratio		400 typ
Optical Rise Time/Fall Time	[msec]	16 typ.
Nominal Input Voltage VDD	[Volt]	+3.3 typ.
Power Consumption	[Watt]	5.2 max.(without inverter)
Weight	[Grams]	365 max.
Physical Size	[mm]	299.5 max. (W) x 195.5 max. (H) x 5.5
Electrical Interface		1 channel LVDS
Surface Treatment		AG, Hardness 3H,
Support Color		262K colors (RGB 6-bit)
Temperature Range		0 to +50
Operating	[°C]	-20 to +60
Storage (Non-Operating)	[°C]	
RoHS Compliance		RoHS Compliance

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2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

Item	Unit	Conditions	Min.	Тур.	Max.	Note
White Luminance Iccfl=6.0mA	[cd/m ²]	5 points average	200	220	-	1, 4, 5.
Viewing Angle	[degree]	Horizontal (Right CR = 10 (Le	eft)	45	-	8
	[degree]		40	45	-	_
	[degree] [degree]	Vertical (Upper CR = 10 (Lower		25	-	
Luminance Uniformity	[a.g.o]	5 Points	30	35	1.25	1
Luminance Uniformity		13 Points			1.50	2
CR: Contrast Ratio			300	400	-	6
Cross talk	%				4	7
Response Time	[msec]	Rising	-	4	8	8
	[msec]	Falling	-	12	17	
	[msec]	Rising + Falling		16	25	
Color / Chromaticity		Red x	0.580	0.600	0.620	2,8
Coordinates (CIE 1931)		Red y	0.330	0.350	0.370	
(0.2 1001)		Green x	0.290	0.310	0.330	
		Green y	0.545	0.565	0.585	
		Blue x	0.135	0.155	0.175	
		Blue y	0.130	0.150	0.170	
		White x	0.293	0.313	0.333	
		White y	0.309	0.329	0.349	

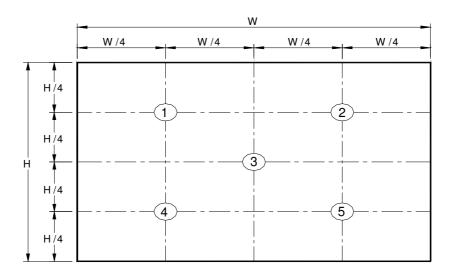
Note 1: 5 points position (Display area : 286.08 (H) x 178.8 (V)mm)

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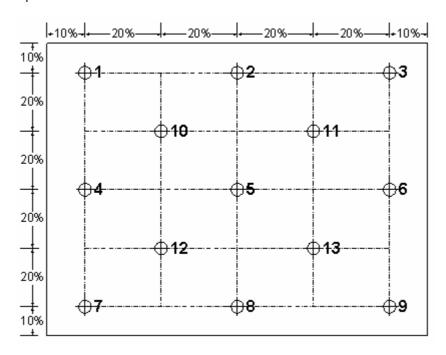


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Note 2: 13 points position



Note 3: The luminance uniformity of 5 and 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

2		Maximum Brightness of five points				
δ w5	=	Minimum Brightness of five points				
2		Maximum Brightness of thirteen points				
δ w13	=	Minimum Brightness of thirteen points				

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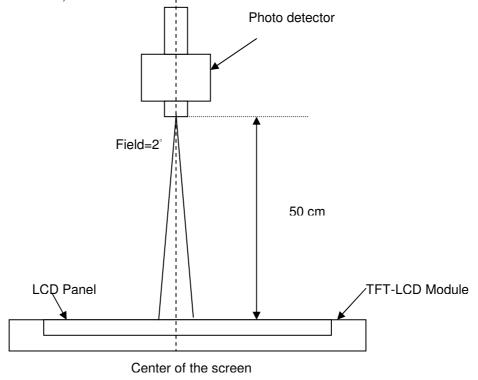


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Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room.



Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points $\cdot Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L(x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Contrast ratio (CR)= $\frac{\text{Brightness on the "White" state}}{\text{Brightness on the "Black" state}}$

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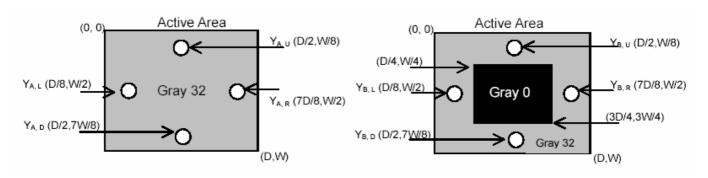
Note 7: Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

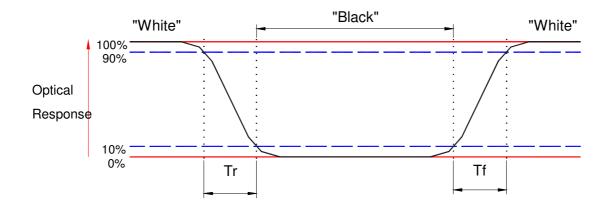
Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

 Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)



Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.



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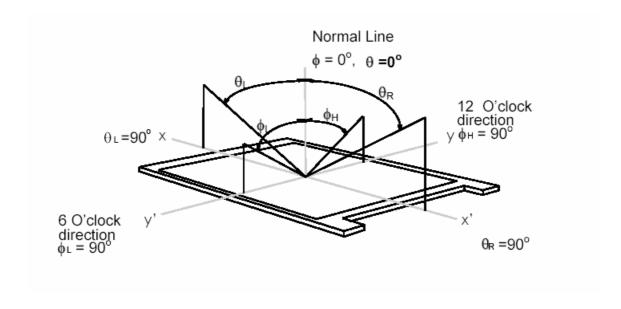


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Note 8. Definition of viewing angle

Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.



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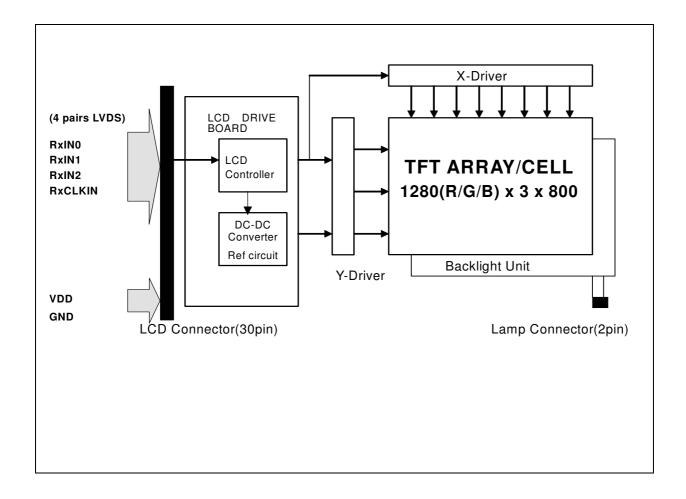


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3. Functional Block Diagram

The following diagram shows the functional block of the 13. 3inches wide Color TFT/LCD Module:



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4. Absolute Maximum Ratings

Absolute maximum ratings of the module are as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Backlight Unit

Item	Symbol	Min	Max	Unit	Conditions
CCFL Current	ICCFL	-	6.5	[mA] rms	Note 1,2

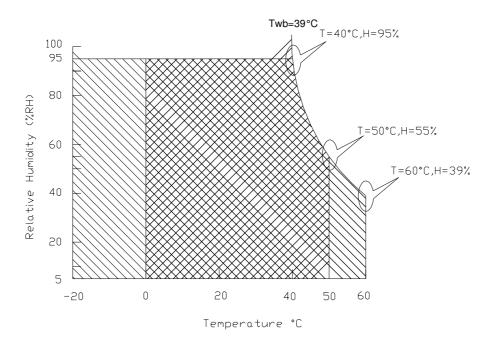
4.3 Absolute Ratings of Environment

Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 3
Operation Humidity	HOP	5	95	[%RH]	Note 3
Storage Temperature	TST	-20	+60	[°C]	Note 3
Storage Humidity	HST	5	95	[%RH]	Note 3

Note 1: At Ta (25°℃)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: For quality performance, please refer to AUO IIS(Incoming Inspection Standard).



Operating Range

Storage Range

+

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5. Electrical characteristics

5.1 TFT LCD Module

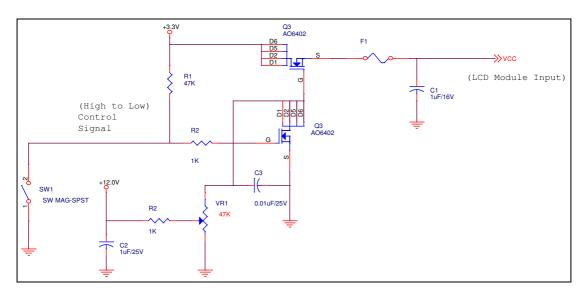
5.1.1 Power Specification

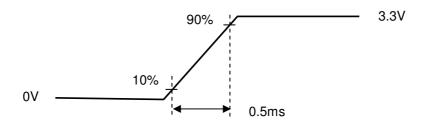
Input power specifications are as follows;

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power			1.0	[Watt]	Note 1
IDD	IDD Current		200	2500	[mA]	Note 1
IRush	Inrush Current			1500	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage			100	[mV]	

Note 1: Maximum Measurement Condition: Black Patterm

Note 2: Measure Condition





Vin rising time

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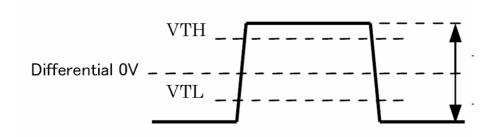
5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
Vth	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
Vtl	Differential Input Low Threshold (Vcm=+1.2V)	-100		[mV]
Vcm	Differential Input Common Mode Voltage	1.0	1.5	[V]

Note: LVDS Differential Voltage



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5.2 Backlight Unit

Parameter guideline for CCFL Inverter

Parameter	Min	Тур	Max	Units	Condition
White Luminance 5 points average	200	220	-	[cd/m ²]	(Ta=25°C)
CCFL current(IccFL)	2.0	6.0	7.0	[mA] rms	(Ta=25°C) Note 2
CCFL Frequency(FCCFL)	45	62	70	[KHz]	(Ta=25°C) Note 3,4
CCFL Ignition Voltage(Vs)	1315			[Volt] rms	(Ta= 0°C) Note 5
CCFL Ignition Voltage(Vs)	1095			[Volt] rms	(Ta= 25°C) Note 5
CCFL Voltage (Reference) (VCCFL)	608	640	672	[Volt] rms	(Ta=25°ℂ) Note 6
CCFL Power consumption (Pccfl)	-	3.85	4.2	[Watt]	(Ta=25°C) Note 6

Note 1: Typ are AUO recommended Design Points.

- *1 All of characteristics listed are measured under the condition using the AUO Test inverter.
- *2 In case of using an inverter other than listed, it is recommended to check the inverter carefully. Sometimes, interfering noise stripes appear on the screen, and substandard luminance or flicker at low power may happen.
- *3 In designing an inverter, it is suggested to check safety circuit very carefully. Impedance of CCFL, for instance, becomes more than 1 [M ohm] when CFL is damaged.
- *4 Generally, CCFL has some amount of delay time after applying kick-off voltage. It is recommended to keep on applying kick-off voltage for 1 [Sec] until discharge.
- *5 CCFL discharge frequency must be carefully chosen so as not to produce interfering noise stripes on the screen.
- *6 Reducing CCFL current increases CCFL discharge voltage and generally increases CCFL discharge frequency. So all the parameters of an inverter should be carefully designed so as not to produce too much leakage current from high-voltage output of the inverter.
- Note 2: It should be employed the inverter which has "Duty Dimming", if ICCFL is less than 4mA.
- Note 3: CCFL discharge frequency should be carefully determined to avoid interference between inverter and TFT LCD.
- Note 4: The frequency range will not affect to lamp life and reliability characteristics.

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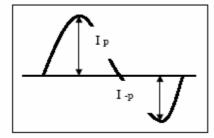
Note 5: CCFL inverter should be able to give out a power that has a generating capacity of over 1,430 voltage. Lamp units need 1,400 voltage minimum for ignition.

Note 6: Calculator value for reference (ICCFL×VCCFL=PCCFL)

Note 7: Requirements for a system inverter design, which is intended to have a better display performance, a better power efficiency and a more reliable lamp, are following.

It shall help increase the lamp lifetime and reduce leakage current.

- a. The asymmetry rate of the inverter waveform should be less than 10%.
- b. The distortion rate of the waveform should be within $\sqrt{2 \pm 10\%}$.
- * Inverter output waveform had better be more similar to ideal sine wave.



* Asymmetry rate:

| p (or | _p) / I_{rms}

* Distortion rate



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6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

		0			1			1	27	8	12	279	9
1st Line	R	G	В	R	G	В		R	G	В	R	G	В
									•				
		1							•				
		•											
		,					· :		•				
									•				
			_	Б				_		ם	_		
800th Line	R	G	В	R	G	В		R	G	В	R	G	В

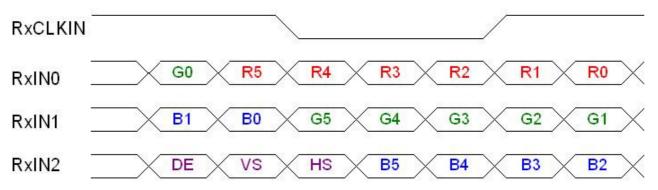
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6.2 The input data format



Signal Name	Description	
R5 R4 R3 R2 R1	Description Red Data 5 (MSB) Red Data 4 Red Data 3 Red Data 2 Red Data 1	Red-pixel Data Each red pixel's brightness data consists of these 6 bits pixel data.
R0	Red Data 0 (LSB) Red-pixel Data	
G5 G4 G3 G2 G1 G0	Green Data 5 (MSB) Green Data 4 Green Data 3 Green Data 2 Green Data 1 Green Data 0 (LSB) Green-pixel Data	Green-pixel Data Each green pixel's brightness data consists of these 6 bits pixel data.
B5 B4 B3 B2 B1 B0	Blue Data 5 (MSB) Blue Data 4 Blue Data 3 Blue Data 2 Blue Data 1 Blue Data 0 (LSB) Blue-pixel Data	Blue-pixel Data Each blue pixel's brightness data consists of these 6 bits pixel data.
RxCLKIN	Data Clock	The typical frequency is 68.9 MHZ The signal is used to strobe the pixel data and DE signals. All pixel data shall be valid at the falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of RxCLKIN. When the signal is high, the pixel data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.

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6.3 Signal Description/Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

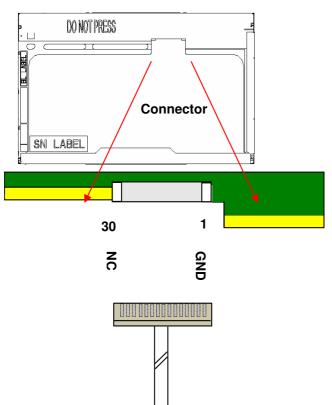
PIN NO	Symbol	ogy for LCD interface and high speed data transfer device. Function
1	GND	Ground
2	VDD	+3.3V Power Supply
3	VDD	+3.3V Power Supply
4	V_{EDID}	+3.3V EDID Power
5	NC	No Connection (Reserve for AUO test)
6	CLK _{EDID}	EDID Clock Input
7	DATA _{EDID}	EDID Data Input
8	RxIN0-	LVDS differential data input(R0-R5, G0)
9	RxIN0+	LVDS differential data input(R0-R5, G0)
10	GND	Ground
11	RxIN1-	LVDS differential data input(G1-G5, B0-B1)
12	RxIN1+	LVDS differential data input(G1-G5, B0-B1)
13	GND	Ground
14	RxIN2-	LVDS differential data input(B2-B5, HS, VS, DE)
15	RxIN2+	LVDS differential data input(B2-B5, HS, VS, DE)
16	GND	Ground
17	RxCLKIN-	LVDS differential clock input
18	RxCLKIN+	LVDS differential clock input
19	GND	Ground
20	GND	Ground
21	NC	No Connection (Reserve for AUO test)
22	NC	No Connection (Reserve for AUO test)
23	NC	No Connection (Reserve for AUO test)
24	NC	No Connection (Reserve for AUO test)
25	NC	No Connection (Reserve for AUO test)
26	NC	No Connection (Reserve for AUO test)
27	NC	No Connection (Reserve for AUO test)
28	NC	No Connection (Reserve for AUO test)
29	NC	No Connection (Reserve for AUO test)
30	NC	No Connection (Reserve for AUO test)

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Note1: Start from right side



Note2: Input signals shall be low or High-impedance state when VDD is off.

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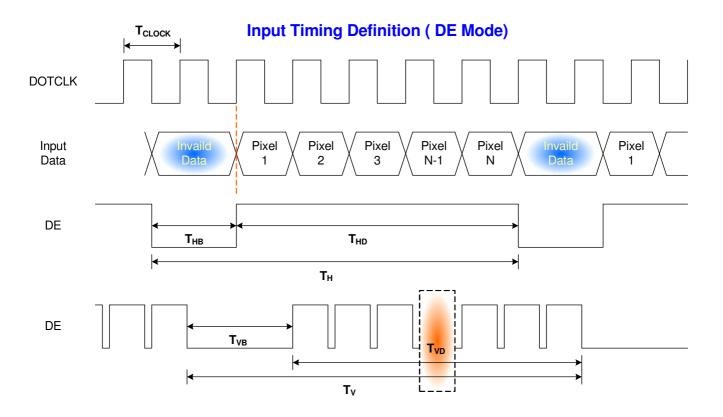
6.4.1 Timing Characteristics

Basically, interface timings should match the 1280x800 /60Hz manufacturing guide line timing.

Parar	Symbol	Min.	Тур.	Max.	Unit	
Frame Rate		-	50	60	-	Hz
Clock fro	equency	1/ T _{Clock}	50	71.1	80	MHz
	Period	T _V	803	823	832	
Vertical	Active	T _{VD}	-	800	-	T_{Line}
Section	Blanking	T_VB	3	23	32	
	Period	T _H	1302	1440	1700	
Horizontal	Active	T_{HD}	-	1280	-	T_{Clock}
Section	Blanking	T _{HB}	22	160	420	

Note: DE mode only

6.4.2 Timing diagram



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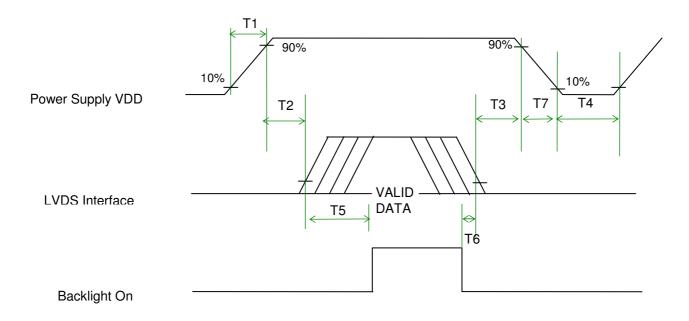


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6.5 Power ON/OFF Sequence

VDD power and lamp on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off.



Power Sequence Timing

Parameter	Min.	Тур.	Max.	Units
T1	0.5	-	10	(ms)
T2	0	-	50	(ms)
Т3	0	-	50	(ms)
T4	400	1	-	(ms)
T5	200	-	-	(ms)
T6	200	-	-	(ms)
T7	0	-	10	(ms)

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7. Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

7.1 TFT LCD Module

Connector Name / Designation	For Signal Connector
Manufacturer	HRS or compatible
Type / Part Number	HRS,MDF76KBW-30S-1H or equivalent
Mating Housing/Part Number	MDF76KBW-30S-1H or equivalent – Locking type connector

7.2 Backlight Unit

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Lamp Connector
Manufacturer	JST
Type / Part Number	BHSR-02VS-1
Mating Type / Part Number	SM02B-BHSS-1-TB

7.3 Signal for Lamp connector

Pin #	Cable color	Signal Name
1	Red	Lamp High Voltage
2	White	Lamp Low Voltage

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8. Vibration and Shock Test

8.1 Vibration Test

Test Spec:

Test method: Non-Operation
 Acceleration: 1.5G, sine wave
 Frequency: 10 - 500Hz Random

• Sweep: 30 Minutes each Axis (X, Y, Z)

8.2 Shock Test Spec:

Test Spec:

• Test method: Non-Operation

Acceleration: 200 G , Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

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9. Reliability

Items	Required Condition	Note		
Temperature Humidity Bias	0°C/90%,300Hr			
High Temperature Operation	60°C/Dry,300Hr			
Low Temperature Operation	0°C,300Hr			
On/Off Test	25°C, ON/30 sec. OFF/30sec., 10,000 cycles)			
Hot Storage	60°C/35% RH ,250 hours			
Cold Storage	-20°ℂ/50% RH ,250 hours			
Thermal Shock Test	-20°C/30 min ,60°C/30 min 100cycles			
Hot Start Test	50°C/1 Hr min. power on/off per 5 minutes, 5 times			
Cold Start Test	0°C/1 Hr min. power on/off per 5 minutes, 5 times			
Shock Test (Non-Operating)	200G, 2ms, Half-sine wave			
Vibration Test (Non-Operating)	Sine-wave vibration, 1.5 G zero-to-peak, 10 to 500 Hz, 30 mins in each of three mutually perpendicular axes.			
ESD	Contact: ±8KV/ operation Air: ±15KV / operation			
Room temperature Test	25°ℂ, 2000hours, Operating with loop pattern			

Note1: According to EN61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

Note2: CCFL Life time: 10,000 hours minimum under normal module usage.

Note3: MTBF (Excluding the CCFL): 30,000 hours with a confidence level 90%

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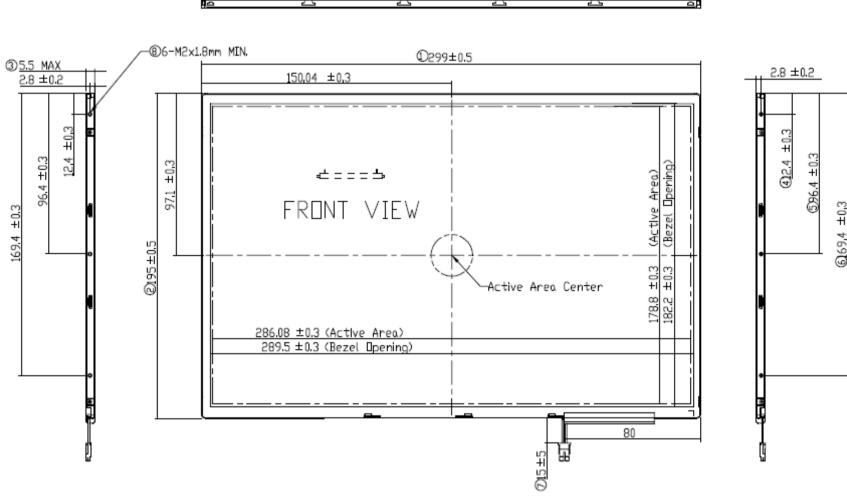


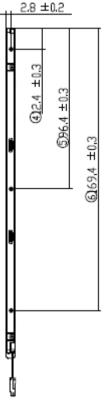
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10. Mechanical Characteristics

10.1 LCM Outline Dimension

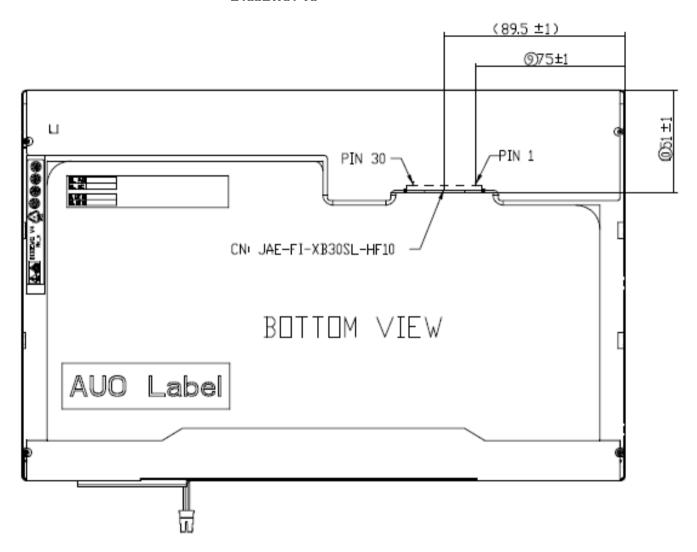






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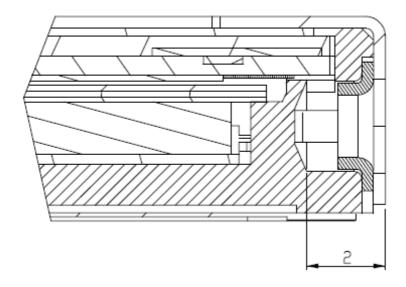
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10.2 Screw Hole Depth and Center Position

Screw hole maximum depth, from side surface =2.0 mm (See drawing)

Screw hole center location, from front surface = 2.8 ± 0.2 mm (See drawing)

Screw Torque: Maximum 2.1 kgf-cm



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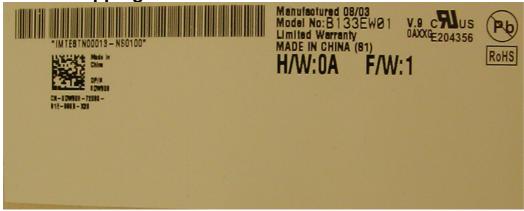


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11. Shipping and Package

11.1 Shipping Label Format



11.2 Definition of customer PPID Label and Revision Code

Please refer to the Dell Part identification Label Specification, Number:13190

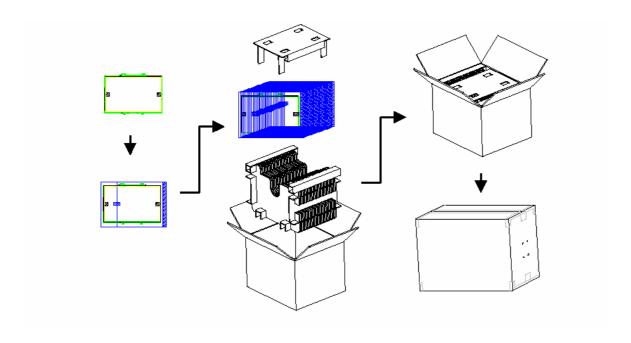
Build Name(s):	PPID Revision Code(s):
Sub System Test (SST)	
Working Sample (WS)	X00, X01, X02,, X0n
ENG 2	
Product Test (PT)	
Engineering Sample (ES)	X10, X11, X12,, X1n
ENG 3	
System Test (ST)	
Customer Sample (CS)	X20, X21, X22, X2n
ENG 4	
X-Build (XB)	
Mass Production (MP)	A00, A01, A02, A0n
ENG 5	

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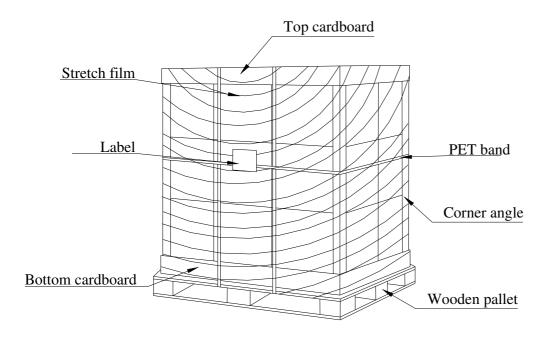


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11.2. Carton package



11.3 Shipping package of palletizing



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12. Appendix: EDID description

Byte	Field Name and Comments	Value	Value	Value
(hex)	r leiu Name and Comments	(hex)	(binary)	(DEC)
0	Header	00	00000000	0
1	Header	FF	11111111	255
2	Header	FF	11111111	255
3	Header	FF	11111111	255
4	Header	FF	11111111	255
5	Header	FF	11111111	255
6	Header	FF	11111111	255
7	Header	00	00000000	0
8	EISA manufacture code = 3 Character ID	06	00000110	6
9	EISA manufacture code (Compressed ASCII)	AF	10101111	175
0A	Panel Supplier Reserved – Product Code	24	00100100	36
0B	Panel Supplier Reserved – Product Code	14	00010100	20
	LCD module Serial No - Preferred but Optional ("0" if			
0C	not used)	00	00000000	0
0.0	LCD module Serial No - Preferred but Optional ("0" if	00	0000000	0
0D	not used) LCD module Serial No - Preferred but Optional ("0" if	00	00000000	0
0E	not used)	00	00000000	0
OL.	LCD module Serial No - Preferred but Optional ("0" if	00	0000000	U
0F	not used)	00	00000000	0
10	Week of manufacture	01	0000001	1
11	Year of manufacture	10	00010000	16
12	EDID structure version # = 1	01	0000001	1
13	EDID revision # = 3	03	00000011	3
14	Video I/P definition = Digital I/P (80h)	80	10000000	128
15	Max H image size (Rounded to cm)	1D	00011101	29
16	Max V image size (Rounded to cm)	12	00010010	18
- 10	Display gamma = (gamma ×100)-100 = Example:	'-	00010010	
17	(2.2×100) – 100 = 120	78	01111000	120
	Feature support (no DPMS, Active off, RGB, timing BLK			
18	1)	0A	00001010	10
19	Red/Green Low bit (RxRy/GxGy)	1C	00011100	28
1A	Blue/White Low bit (BxBy/WxWy)	F5	11110101	245
1B	Red X $Rx = 0$.	97	10010111	151
1C	Red Y Ry = 0.	58	01011000	88
1D	Green X $Rx = 0$.	50	01010000	80
1E	Green Y Ry = 0.	8E	10001110	142

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1F	Blue X $Rx = 0$.	27	00100111	39
20	Blue Y Ry = 0.	27	00100111	39
21	White X $Rx = 0$.	50	01010000	80
22	White Y $Ry = 0$.	54	01010100	84
23	Established timings 1 (00h if not used)	00	00000000	0
24	Established timings 2 (00h if not used)	00	00000000	0
25	Manufacturer's timings (00h if not used)	00	00000000	0
26	Standard timing ID1 (01h if not used)	01	00000001	1
27	Standard timing ID1 (01h if not used)	01	00000001	1
28	Standard timing ID2 (01h if not used)	01	00000001	1
29	Standard timing ID2 (01h if not used)	01	00000001	1
2A	Standard timing ID3 (01h if not used)	01	00000001	1
2B	Standard timing ID3 (01h if not used)	01	00000001	1
2C	Standard timing ID4 (01h if not used)	01	00000001	1
2D	Standard timing ID4 (01h if not used)	01	00000001	1
2E	Standard timing ID5 (01h if not used)	01	00000001	1
2F	Standard timing ID5 (01h if not used)	01	0000001	1
30	Standard timing ID6 (01h if not used)	01	00000001	1
31	Standard timing ID6 (01h if not used)	01	0000001	1
32	Standard timing ID7 (01h if not used)	01	0000001	1
33	Standard timing ID7 (01h if not used)	01	0000001	1
34	Standard timing ID8 (01h if not used)	01	0000001	1
35	Standard timing ID8 (01h if not used)	01	0000001	1
	Pixel Clock/10,000			
36	(LSB)	C7	11000111	199
37	Pixel Clock/10,000 (MSB)	1B	00011011	27
38	Horizontal Active = pixels (lower 8 bits)	00	00000000	0
- 55	Horizontal Blanking (Thbp) = 320 pixels	- 00	0000000	0
39	(lower 8 bits)	A0	10100000	160
	Horizontal Active/Horizontal blanking (Thbp)			
3A	(upper4:4 bits)	50	01010000	80
3B	Vertical Active = lines	20	00100000	32
	Vertical Blanking (Tvbp) = lines (DE Blanking typ. for			
3C	DE only panels)	17	00010111	23
3D	Vertical Active : Vertical Blanking (Tvbp) (upper4:4 bits)	30	00110000	48
3E	Horizontal Sync, Offset (Thfp) = pixels	30	00110000	48
3F	Horizontal Sync, Pulse Width = pixels	20	00100000	32
40	Vertical Sync, Offset (Tvfp) = lines	36	00110110	54

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	lines			
41	Horizontal Vertical Sync Offset/Width upper 2 bits	00	00000000	0
42	Horizontal Image Size =	22	00100010	34
43	Vertical image Size =	B4	10110100	180
44	Horizontal Image Size / Vertical image size	10	00010000	16
45	Horizontal Border = 0 (Zero for Notebook LCD)	00	00000000	0
46	Vertical Border = 0 (Zero for Notebook LCD)	00	00000000	0
47	Non-interlaced, Normal, no stereo, Separate sync, H/V pol Negatives, DE only note: LSB is set to "1" if panel is DE-timing only. H/V can be ignored.	19	00011001	25
48	Pixel Clock/10,000 (LSB)	26	00100110	38
49	Pixel Clock/10,000 (MSB)	17	00010111	23
4A	Horizontal Active = xxxx pixels (lower 8 bits)	00	00000000	0
4B	Horizontal Blanking (Thbp) = xxxx pixels (lower 8 bits)	A0	10100000	160
4C	Horizontal Active/Horizontal blanking (Thbp) (upper4:4 bits)	50	01010000	80
4D	Vertical Active = xxxx lines	20	00100000	32
4E	Vertical Blanking (Tvbp) = xxxx lines (DE Blanking typ. for DE only panels)	17	00010111	23
4F	Vertical Active : Vertical Blanking (Tvbp) (upper4:4 bits)	30	00110000	48
50	Horizontal Sync, Offset (Thfp) = xxxx pixels	30	00110000	48
51	Horizontal Sync, Pulse Width = xxxx pixels	20	00100000	32
52	Vertical Sync, Offset (Tvfp) = xx lines Sync Width = xx lines	36	00110110	54
53	Horizontal Vertical Sync Offset/Width upper 2 bits	00	00000000	0
54	Horizontal Image Size =xxx mm	22	00100010	34
55	Vertical image Size = xxx mm	B4	10110100	180
56	Horizontal Image Size / Vertical image size	10	00010000	16
57	Horizontal Border = 0 (Zero for Notebook LCD)	00	00000000	0
58	Vertical Border = 0 (Zero for Notebook LCD)	00	00000000	0
59	Module "A" Revision = Example: 00, 01, 02, 03, etc.	00	00000000	0
5A	Flag	00	00000000	0
5B	Flag	00	00000000	0
5C	Flag	00	00000000	0
5D	Dummy Descriptor	FE	11111110	254
5E	Flag	00	00000000	0
5F	Dell P/N 1 st Character	58	01011000	88

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60	Dell P/N 2 nd Character	55	01010101	85
61	Dell P/N 3 rd Character	32	00110010	50
62	Dell P/N 4 th Character	39	00111001	57
63	Dell P/N 5 th Character	30	00110000	48
64	LCD Supplier EEDID Revision #	00	00000000	0
65	Manufacturer P/N	42	01000010	66
66	Manufacturer P/N	31	00110001	49
67	Manufacturer P/N	33	00110011	51
68	Manufacturer P/N	33	00110011	51
69	Manufacturer P/N	45	01000101	69
6A	Manufacturer P/N	57	01010111	87
6B	Manufacturer P/N (If <13 char, then terminate with ASCII code 0Ah, set remaining char = 20h)	31	00110001	49
6C	Flag	00	00000000	0
6D	Flag	00	00000000	0
6E	Flag	00	00000000	0
6F	Data Type Tag:	FE	11111110	254
70	Flag	00	00000000	0
71	SMBUS Value	31	00110001	49
72	SMBUS Value	43	01000011	67
73	SMBUS Value	52	01010010	82
74	SMBUS Value	58	01011000	88
75	SMBUS Value	7D	01111101	125
76	SMBUS Value	A1	10100001	161
77	SMBUS Value	СВ	11001011	203
78	SMBUS Value	FF	11111111	255
79	Number of LVDS receiver chips = (01 or 02)	01	00000001	1
7A	BIST Enable: Yes	01	0000001	1
7B	(If <13 char, then terminate with ASCII code 0Ah, set remaining char = 20h)	0A	00001010	10
7C	(If <13 char, then terminate with ASCII code 0Ah, set remaining char = 20h)	20	00100000	32
70	(If <13 char, then terminate with ASCII code 0Ah, set	20	0010000	02
7D	remaining char = 20h)	20	00100000	32
7E	Extension flag (# of optional 128 EDID extension blocks to follow, Typ = 0)	00	00000000	0
7F	Checksum (The 1-byte sum of all 128 bytes in this EDID block shall = 0)	F9	11111001	249

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